PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2854558

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SATHEESH JAYAKUMAR	01/06/2014
XINTIAN LI	01/06/2014
ZHIKAI TANG	01/06/2014
WEI CHEN	12/23/2013

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED	
Street Address:	5775 MOREHOUSE DRIVE	
City:	SAN DIEGO	
State/Country:	CALIFORNIA	
Postal Code:	92121-1714	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14135061	

CORRESPONDENCE DATA

Fax Number: (503)439-6558

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

 Phone:
 503 439 6500

 Email:
 qc@bltg-ip.com

Correspondent Name: BERKELEY LAW & TECHNOLOGY GROUP, LLP

Address Line 1: 17933 NW EVERGREEN PARKWAY

Address Line 2: SUITE 250

Address Line 4: BEAVERTON, OREGON 97006

ATTORNEY DOCKET NUMBER:	133566 (051.P482)
NAME OF SUBMITTER:	TINA MILLER
SIGNATURE:	/Tina Miller/
DATE SIGNED:	05/14/2014

Total Attachments: 6

source=133566_Assignment#page1.tif source=133566_Assignment#page2.tif

PATENT 502807964 REEL: 032885 FRAME: 0919

source=133566_Assignment#page3.tif
source=133566_Assignment#page4.tif
source=133566_Assignment#page5.tif
source=133566_Assignment#page6.tif

ASSIGNMENT

WHEREAS, WE,

- 1. Satheesh Jayakumar, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Fremont, CA,
- 2. **Xintian Li,** a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Cupertino, CA.
- 3. Zhikai Tang, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Santa Clara, CA,
- 4. Wei Chen, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHODS AND APPARATUSES FOR USE IN PROVIDING LOCATION PARAMETERS TO MOBILE APPLICATIONS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/135,061 filed December 19, 2013, Qualcomm Reference No. 133566, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/842,916, filed July 3, 2013, Qualcomm Reference No. 133566P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Santh Coapa, on 1 2014

LOCATION DATE Satheesh Jayakumar

ASSIGNMENT

WHEREAS, WE,

- 1. Satheesh Jayakumar, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Fremont, CA,
- 2. Xintian Li, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Cupertino, CA,
- 3. Zhikai Tang, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Santa Clara, CA,
- 4. Wei Chen, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHODS AND APPARATUSES FOR USE IN PROVIDING LOCATION PARAMETERS TO MOBILE APPLICATIONS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/135,061 filed December 19, 2013, Qualcomm Reference No. 133566, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/842,916, filed July 3, 2013, Qualcomm Reference No. 133566P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

PATENT

QUALCOMM Ref. No. 133566 Page 3 of 3

Done at SANTA CLARA, o	m 16/2014	
LOCATION	DATE	Xintian Li
Done at SANTA CLAMA, , o	m 1/6/2011	Herry
LOCATION	DATE	Zhikai Tang
Done at, c	on	
TOCATION	DATE	Wai Chan

ASSIGNMENT

WHEREAS, WE,

- 1. Satheesh Jayakumar, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Fremont, CA,
- 2. Xintian Li, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Cupertino, CA.
- 3. Zhikai Tang, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Santa Clara, CA,
- 4. Wei Chen, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHODS AND APPARATUSES FOR USE IN PROVIDING LOCATION PARAMETERS TO MOBILE APPLICATIONS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/135,061 filed December 19, 2013, Qualcomm Reference No. 133566, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/842,916, filed July 3, 2013, Qualcomm Reference No. 133566P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

PATENT QUALCOMM Ref. No. 133566 Page 3 of 3

Done at	,,	on	
interces.	LOCATION	DATE	Xintian Li
Done at _	• *	on	
	LOCATION	DATE	Zhikai Tang
Done at _	Szn Diego "	on 12/23/2013	allu_
-	LOCATION	DATE	Wei Chen

PATENT REEL: 032885 FRAME: 0926

RECORDED: 05/14/2014